

C1206C561J1GACTU

Aliases (C1206C561J1GAC7800) SMD Comm COG, Ceramic, 560 pF, 5%, 100 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	15 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		Specifications
Chip Size	1206	Capacitance
L	3.2mm +/-0.2mm	Measurement Conc
W	1.6mm +/-0.2mm	Tolerance
Т	0.78mm +/-0.10mm	Voltage DC
S	1.5mm MIN	Dielectric Withstand
В	0.5mm +/-0.25mm	Temperature Range
		Temp. Coefficient
Packaging Specifications		Conseitence Chang

T&R, 180mm, Plastic Tape

4000

	Capacitance	560 pF
	Measurement Condition	1 MHz 1.0Vrms
	Tolerance	5%
	Voltage DC	100 VDC
	Dielectric Withstanding Voltage	250 VDC
	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
	Dissipation Factor	0.1% 1 MHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour

100 GOhms Insulation Resistance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Packaging

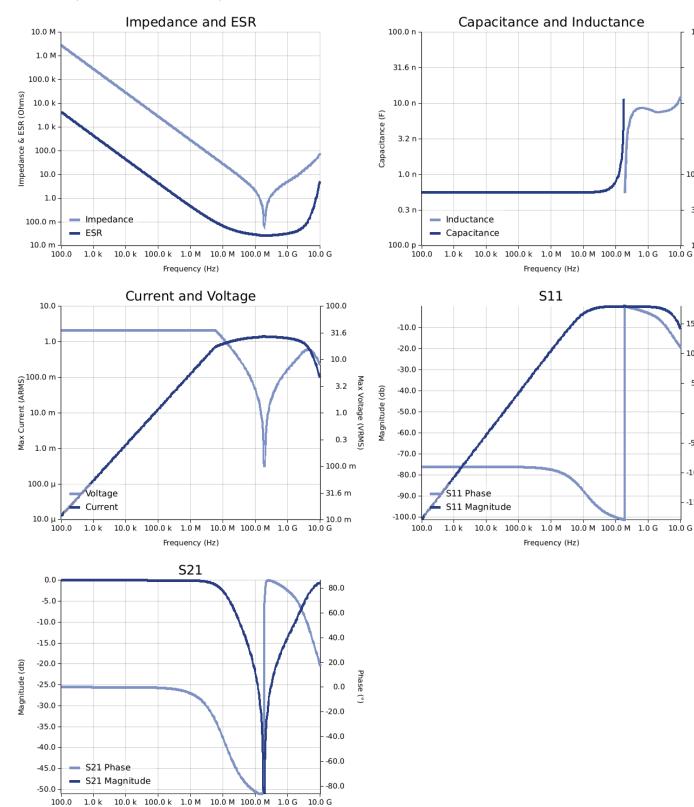
Packaging Quantity



C1206C561J1GACTU Aliases (C1206C561J1GAC7800) SMD Comm C0G, Ceramic, 560 pF, 5%, 100 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206, 1.5 mm

Simulations

For the complete simulation environment please visit K-SIM.



Frequency (Hz)

10.0 n

3.2 n

1.0 n

0.3 n

31.6 p

10.0 p

150.0

100.0

50.0

0.0

-50.0

-100.0

-150.0

Phase (°)

inductance

(<u>±</u> 100.0 p



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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for hipple klipple current younge vs. requericy plots is the ESR at an bient temperature.
 The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
 The effects shown herein are based on measured data from a multiple part sample of the parts in question.
 Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages are not combined with voltages.
- generated at any other harmonics.
 Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.